

# Search Notes

L Number	Hits	Search Text	DB	Time stamp
-	0	insulation adj collar and tto and sti	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:04
-	62	tto and sti	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:03
-	61	tto and sti and dram	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:03
-	5	tto and sti and dram and epitaxial	USPAT; US-PGPUB;	2004/07/07 23:06
-	13	trench adj capacitor and sti and dram and epitaxial and insulation adj collar	EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:07
-	15	trench adj capacitor and sti and dram and epitaxial\$3 and insulation adj collar	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:07
-	15	trench adj capacitor and sti and dram and epitaxial\$3 and insulation adj collar and dram	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:07
-	13	trench adj capacitor and sti and dram and epitaxial\$3 and insulation adj collar and transistor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:08
-	7	trench adj capacitor and sti and dram and epitaxial\$3 and insulation adj collar and selection adj transistor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/07 23:08
-	10	((("5,744,386") or ("5,827,765") or ("5,670,805") or ("5,360,758") or ("6,509,599"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:07
-	1032	(257/301).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:07
-	467	(257/304).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:08
-	47	(438/388).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:08

-	85	(438/392).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:08
-	506	(438/386).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:08
-	789	(438/239).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:08
-	76	(438/245).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:09
-	111	(438/249).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:09
-	936	(438/238).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/07/08 13:09